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WATANABE, Teiji (December 12, 2000)  
NAKAMURA, Masafumi (December 12, 2000)  
NAKAMURA, Yoshikazu (December 12, 2000)

12/19/00

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

## 2. Name and address of receiving party(ies):

HONDA GIKEN KOGYO KABUSHIKI KAISHA  
1-1, Minami-Aoyama 2-chome  
Minato-ku, Tokyo  
JAPANAdditional name(s) & address(es) attached? ☐ Yes ☒ No

## 3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other:

Execution Date: December 12, 2000

## 4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: December 12, 2000

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

## 5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Curtis B. Hamre  
Address: Merchant & Gould P.C.  
P.O. Box 2903  
Minneapolis, MN 55402-0903

## 7. Total fee (37 CFR 3.41): \$40.00

- ☒ Enclosed  
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Name of Person Signing

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INSTRUCTIONS

ASSIGNMENT TO CORPORATION (FOR USA ONLY)

WHEREAS,  
 Inventor(s) Name 1. Teiji Watanabe residing at c/o Honda Giken Kogyo Kabushiki Kaisha,  
 Hamamatsu Plant. 13-1, Aoi-Higashi 1-chome, Hamamatsu-shi, Shizuoka, Japan  
 and a citizen of Japan  
 2. Masafumi Nakamura residing at c/o Honda Giken Kogyo Kabushiki Kaisha,  
 Hamamatsu Plant. 13-1, Aoi-Higashi 1-chome, Hamamatsu-shi, Shizuoka, Japan  
 and a citizen of Japan  
 3. Yoshikazu Nakamura residing at c/o Honda Giken Kogyo Kabushiki Kaisha,  
 Hamamatsu Plant. 13-1, Aoi-Higashi 1-chome, Hamamatsu-shi, Shizuoka, Japan  
 and a citizen of Japan  
 Date Patent Declaration Signed and Title: Serial No. and Filing (herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on \_\_\_\_\_ for this invention, which application is entitled see ( \* ) below and which has been given Serial Number \_\_\_\_\_ and the filing date of \_\_\_\_\_  
 Name of Corporation AND WHEREAS HONDA GIKEN KOGYO KABUSHIKI KAISHA (herein called "ASSIGNEE"), a corporation organized under the laws of Japan, and having an office and place of business at 1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo  
 State or Country of Incorporation and Address wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for all countries in and to the invention disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that the UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignment and other documents, and will communicate to said ASSIGNEE, its successors and representative all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the date indicated below.

Each inventor must sign & date

Teiji Watanabe  
Signature

December 12, 2000  
Date

Note: No legalization or other witness required

Masafumi Nakamura  
Signature

December 12, 2000  
Date

Yoshikazu Nakamura  
Signature

December 12, 2000  
Date

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MERCHANT & GOULD

\* METHOD FOR FABRICATING PRESS FORMING DIE, METHOD FOR FABRICATING PRESS FORMING PUNCH, AND PRESS FORMING DIE ASSEMBLY